

PATENT ASSIGNMENT COVER SHEET

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| Name | Execution Date |
| YOUNG JIN JEONG | 03/26/2015 |
| JUN YOUNG SONG | 03/26/2015 |
| DONG HWAN CHO | 03/24/2015 |
| BYUNG KUK KIM | 03/24/2015 |
| RECEIVING PARTY DATA | |
| Name: | SOONGSIL UNIVERSITY RESEARCH CONSORTIUM TECHNO-PARK |
| Street Address: | (SANGDO-DONG) 369 |
| Internal Address: | SANGDO-RO DONGJAK-GU |
| City: | SEOUL |
| State/Country: | KOREA, REPUBLIC OF |
| Postal Code: | 156-030 |
| PROPERTY NUMBERS Total: 1 | |
| Property Type | Number |
| Application Number: | 14390463 |
| CORRESPONDENCE DATA | |
| Fax Number: | (763)571-5157 |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> | |
| Phone: | 763.412.3824 |
| Email: | patents@daiplaw.com |
| Correspondent Name: | CURTIS B. HERBERT, PH.D. |
| Address Line 1: | DARDI & HERBERT, PLLC |
| Address Line 2: | 1250 EAST MOORE LAKE DRIVE, SUITE 205 |
| Address Line 4: | FRIDLEY, MINNESOTA 55432 |
| ATTORNEY DOCKET NUMBER: | 5082.07US01 |
| NAME OF SUBMITTER: | CURTIS B. HERBERT, PH.D. |
| SIGNATURE: | /Curtis B. Herbert/ |
| DATE SIGNED: | 03/31/2015 |
| Total Attachments: 3 | |

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ASSIGNMENT

WHEREAS, we, Young Jin JEONG of Seoul, Republic of Korea and Jun Young SONG of Gyeonggi-Do, Republic of Korea, and Dong Hwan CHO of Gyeongsangbuk-Do, Republic of Korea, and Byung Kuk KIM of Daegu, Republic of Korea, have invented certain new and useful improvements in METHOD FOR PREPARING CARBON NANOTUBE FIBER REINFORCED WITH CARBON PRECURSOR, for which an application for Letters Patent of the United States has been made, and which may be identified in the United States Patent Office by Application No. 14/390,463, filed October 3, 2014.

WHEREAS, Soongsil University Research Consortium Techno-Park ("Assignee"), having its principal offices at (Sangdo-Dong) 369, Sangdo-Ro Dongjak-Gu, Seoul, 156-030, Republic of Korea, is desirous of acquiring the entire right, title and interest in and to said invention, said application and in, to and under any and all Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of One Dollar (\$1.00) and other good and valuable consideration to us in hand paid by said Assignee, the receipt of which is hereby acknowledged, we have sold, assigned and transferred, and by these presents do hereby sell, assign and transfer unto the said Assignee, its successors and assigns, our entire right, title and interest in and to said invention, said application, all applications claiming priority to said application including all divisions, continuations or renewals thereof, and the Letters Patent, both foreign and domestic, that may or shall issue, therefrom including all reissues or extensions of such patents including all of our rights under the International Convention, and we do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to the above mentioned Assignee in accordance herewith.

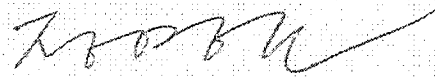
We hereby authorize the above mentioned Assignee, its successors and assigns, or anyone it may properly designate, to insert in this instrument the date of execution and/or filing date and application number of said application when ascertained.

We further authorize said Assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent, in its own name if desired, in any and all foreign countries, and additionally to claim the filing date of said United States application and/or otherwise take advantage of the provisions of the International Convention.

Upon said consideration we do hereby covenant and agree with the said Assignee, its successors and assigns, that we will not execute in writing or do any act whatsoever conflicting with these presents, and that we or our executors or administrators will at any time upon request, without further or additional consideration, but at the expense of the said Assignee, its successors and assigns, execute such additional writings and do such additional acts as said Assignee, its successors and assigns, may deem necessary or desirable to perfect the Assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, or of any and all foreign countries on said invention, and in enforcing any rights occurring as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents.

IN WITNESS WHEREOF, we have hereunto set our hands and affixed our seal as dated below.

Date: March/26/2015



Young Jin JEONG

Date: 2015. 03. 26

Yoo, Dong Hee

Witness One Printed Name



Witness One Signature

Date: March 26, 2015

Nam, Tae woo

Witness Two Printed Name

Nam

Witness Two Signature

Date: March/26/2015

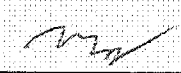


Jun Young SONG

Date: 2015. 03. 26

Yoo, Dong Hee

Witness One Printed Name



Witness One Signature

Date: March 26, 2015

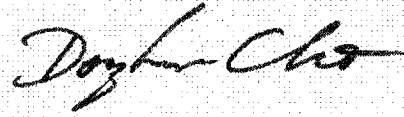
Nam, Tae woo

Witness Two Printed Name

Nam

Witness Two Signature

Date: March/24/2015

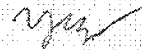


Dong Hwan CHO

Date: 2015.03.24

Yoo, Dong Hee

Witness One Printed Name



Witness One Signature

Date: March 24, 2015

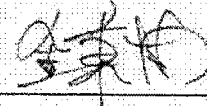
Nam, Tae woo

Witness Two Printed Name

Nam

Witness Two Signature

Date: March/24/2015

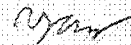


Byung Kuk KIM

Date: 2015 03 24

Yoo, Dong Hee

Witness One Printed Name



Witness One Signature

Date: March 24, 2015

Nam Tae woo

Witness Two Printed Name

Nam

Witness Two Signature